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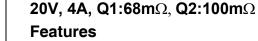
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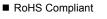
FDMC6890NZ

Q1: N-Channel

- Max $r_{DS(on)}$ = 68m Ω at V_{GS} = 4.5V, I_D = 4A
- Max $r_{DS(on)}$ = 100m Ω at V_{GS} = 2.5V, I_D = 3A

Q2: N-Channel

- Max $r_{DS(on)}$ = 100m Ω at V_{GS} = 4.5V, I_D = 4A
- Max $r_{DS(on)}$ = 150m Ω at V_{GS} = 2.5V, I_D = 2A
- Low gate Charge





Dual N-Channel PowerTrench[®] MOSFET

General Description

FDMC6890NZ is a compact single package solution for DC to DC converters with excellent thermal and switching characteristics. Inside the Power 33 package features two N-channel MOSFETs with low on-state resistance and low gate charge to maximize the power conversion and switching efficiency. The Q1 switch also integrates gate protection from unclamped voltage input.

Application

DC - DC Conversion

Up Bottom S1 D1/S2 D2 G1 D1/S2 G2 D2G1 D1/S2 G2 D1/S2 D1/S2

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units
V _{DS}	Drain to Source Voltage		20	20	V
V _{GS}	Gate to Source Voltage		±12	±12	V
I _D	-Continuous		4		Α
	-Pulsed		1	10	
-	Power Dissipation (Steady State) Q1	(Note 1a)	1.92		14/
P _D	Power Dissipation (Steady State) Q2		1.78		W
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150		°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	Q1	(Note 1a)	65	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	Q2		70	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
6890N	FDMC6890NZ	Power 33	7inch	8mm	3000 units

October 2006

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Мах	Units
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	Q1 Q2	20 20			V
ΔΒV _{DSS} ΔΤ _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$	Q1 Q2		13 12		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16V, V _{GS} = 0V	Q1 Q2			1 1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±12V, V_{DS} = 0V	Q1 Q2			±10 ±100	μA nA
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	Q1 Q2	0.6 0.6	0.9 1.0	2 2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$	Q1 Q2		-3 -3		mV/°C
-	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 4A$ $V_{GS} = 2.5V, I_D = 3A$	Q1		58 77	68 100	
r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 4A$ $V_{GS} = 2.5V, I_D = 2A$	Q2		67 102	100 150	- mΩ
9fs	Forward Transconductance	$V_{DS} = V, I_D = 4A$	Q1 Q2		10 7		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 10V, V _{GS} = 0V, f= 1MHZ	Q1 Q2		205 190	270 250	pF
C _{oss}	Output Capacitance		Q1 Q2		60 60	80 80	pF
C _{rss}	Reverse Transfer Capacitance		Q1 Q2		40 35	60 55	pF
		+				1	

Switching Characteristics

Gate Resistance

 R_g

t _{d(on)}	Turn-On Delay Time		Q1 Q2	4 4	10 10	ns
t.	Rise Time	V_{DD} = 10V, I_{D} = 4A, R_{GEN} = 6 Ω	Q1	13	22	ns
ι _r		$v_{\rm DD} = 10 v, 10 = 4A, 10 GEN = 002$	Q2	12	21	
1	Turn Off Dolou Time		Q1	10	19	
t _{d(off)}	Turn-Off Delay Time		Q2	7	14	ns
			Q1	6	12	
t _f	Fall Time		Q2	6	12	ns
<u> </u>			Q1	2.4	3.4	-0
Q _{g(TOT)}	Total Gate Charge at 4.5V	$V_{GS} = 0V$ to 4.5V	Q2	1.8	2.6	nC
0	Total Cata Charge at 21/		Q1	1.4	1.9	
Q _{g(2)}	Total Gate Charge at 2V	V _{DD} = 10 V I _D = 4A	Q2	0.6	0.8	nC
0		$I_{\rm D} = 4A$	Q1	0.4		
Q _{gs}	Gate to Source Gate Charge		Q2	0.5		nC
0	O sta ta Dasia "Millar" Olaraza		Q1	0.9		-0
Q _{gd}	Gate to Drain "Miller" Charge		Q2	0.8		nC

f = 1MHz

Q1

Q2

3.3

2.8

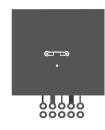
Ω

FDMC6890NZ Dual N-Channel PowerTrench[®] MOSFET

FDMC6890N2
NZ Dual
N-Channel
PowerTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Drain-Sou	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 4A$	Q1 Q2		0.94 0.92	1.25 1.25	V
t _{rr}	Reverse Recovery Time	I _F = 4A, di/dt = 100A/s	Q1 Q2		18 17	27 26	ns
Q _{rr}	Reverse Recovery Charge		Q1 Q2		9 10	14 15	nC

Notes:
1: R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

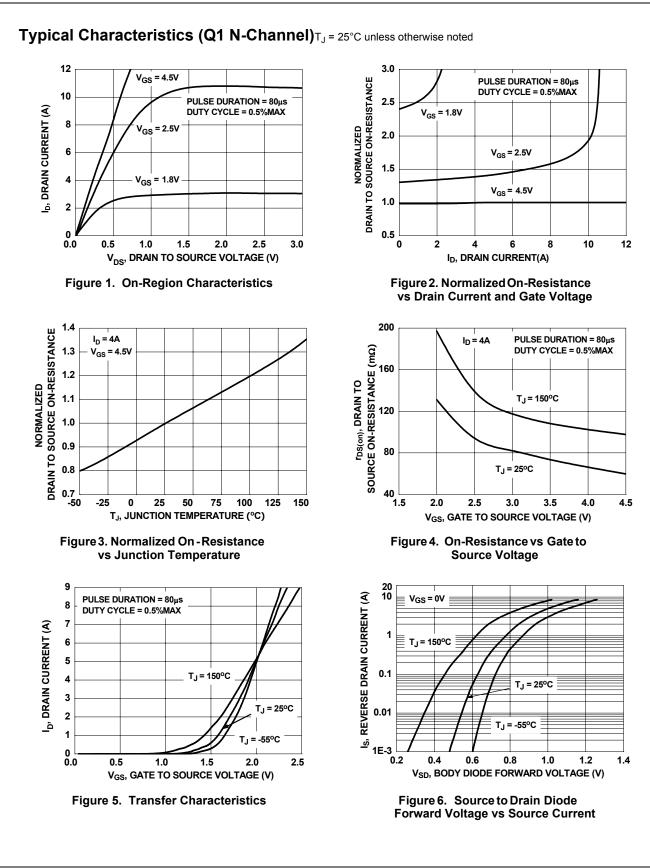


2: Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0%.

a. 65°C/W when mounted on a 1 in² pad of 2 oz copper

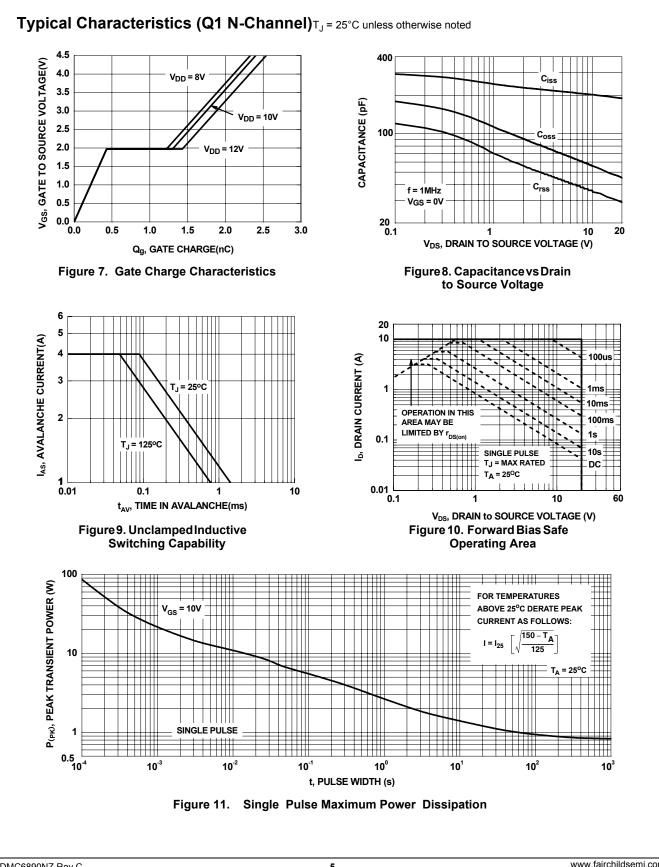
b. 150°C/W when mounted on a minimum pad of 2 oz copper





FDMC6890NZ Rev.C

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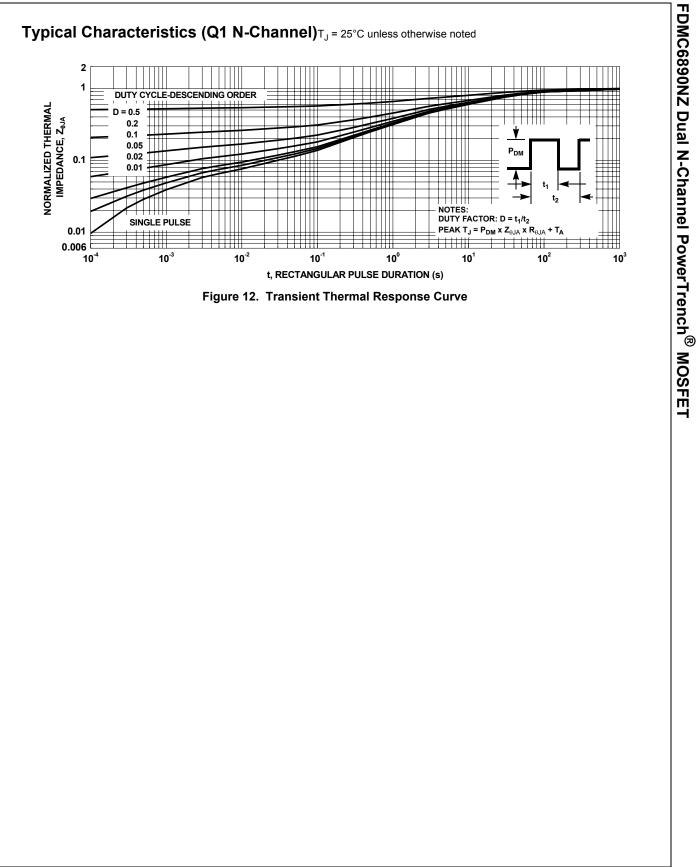


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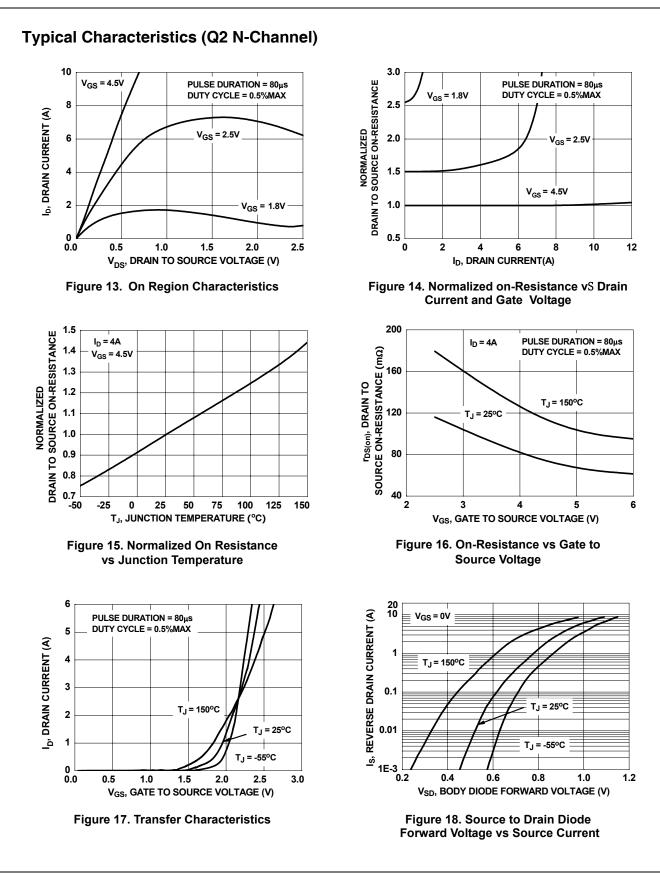
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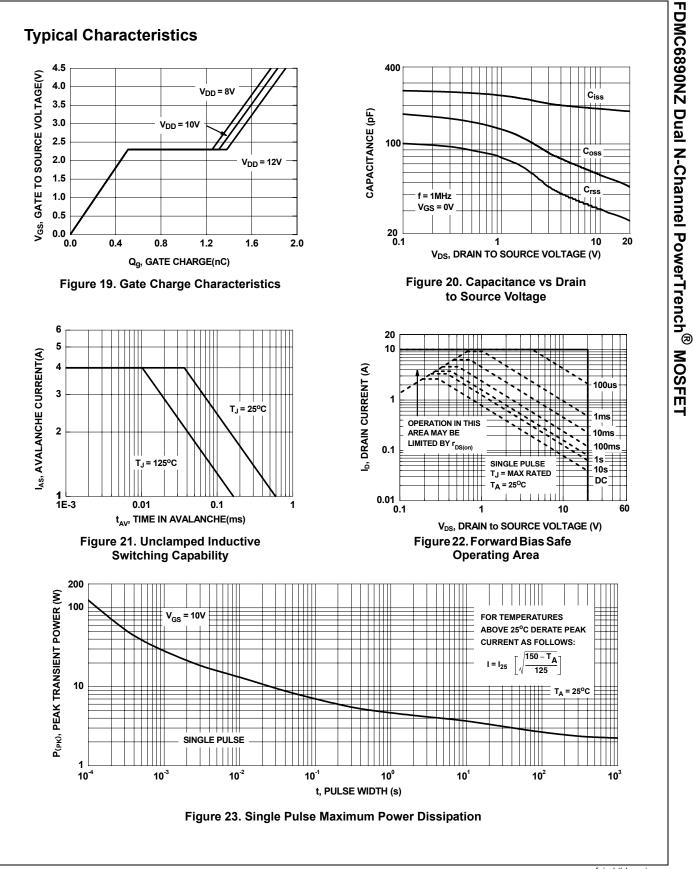
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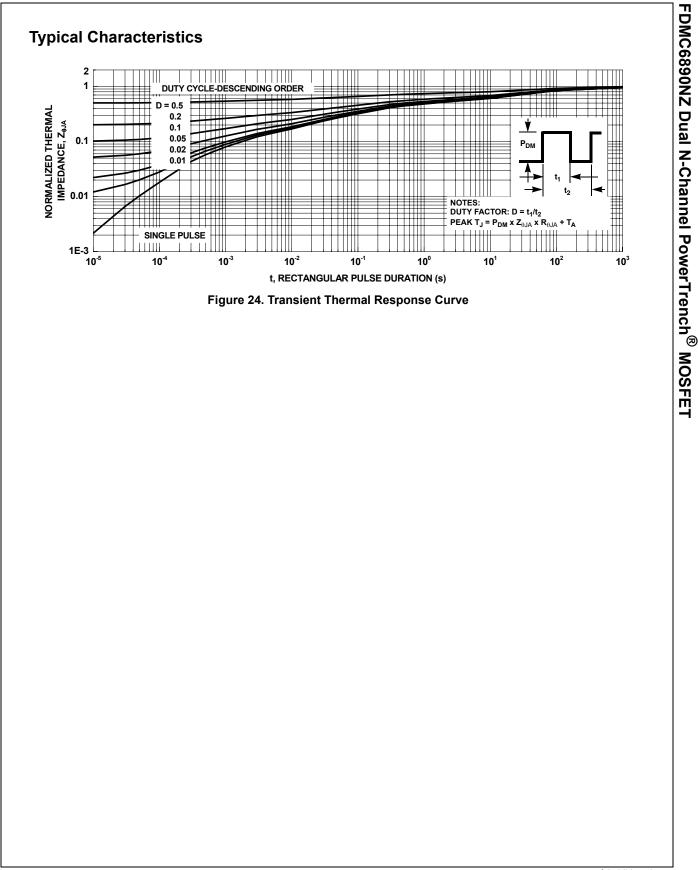
FDMC6890NZ Dual N-Channel PowerTrench[®] MOSFET



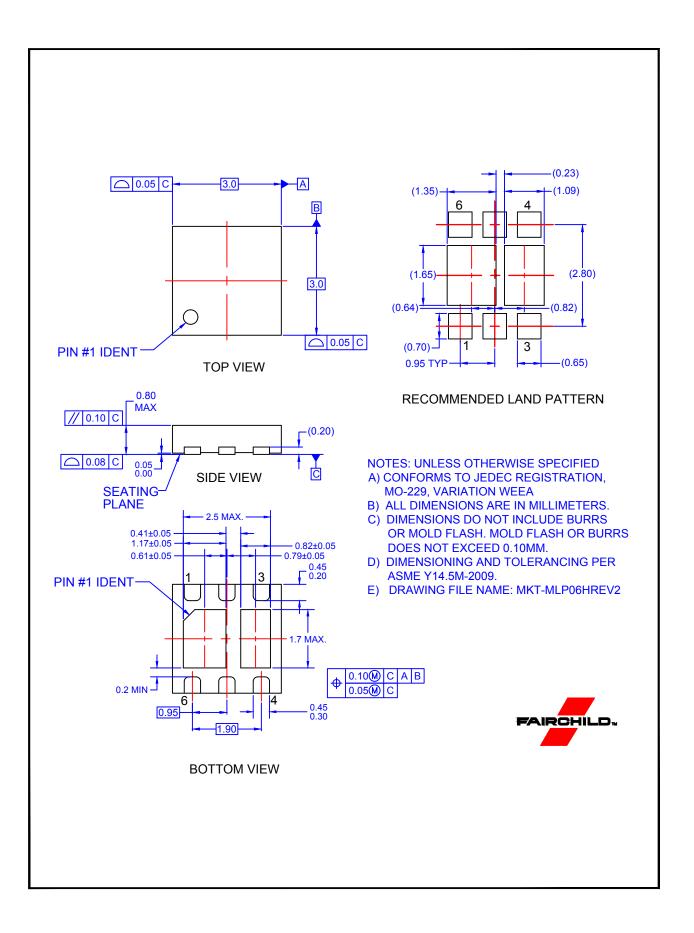
FDMC6890NZ Dual N-Channel PowerTrench[®] MOSFET







FDMC6890NZ Rev.C



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